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• NOT ADMITTED IN NEW YORK • REGISTERED PATENT AGENT

BY EXPRESS MAIL ON July 12, 2001 (EK 825 216 945 US)

BOX PATENT APPLICATION ASSISTANT COMMISSIONER FOR PATENTS Washington, DC 20231

## RECORD OF TRANSMITTAL

**INVENTORS:** (1) Ryoichi MATSUOKA

SEMICONDUCTOR WAFER PATTERN SHAPE EVALUATION METHOD AND TITLE:

**DEVICE** 

S004-4330 DOCKET NO:

S I R:

Kindly find enclosed herewith for filing the documents checked below. Any fees or charges not covered by the accompanying check should be charged to our Deposit Account No. 01-0268.

XX PATENT APPLICATION (pages 1-12 of specification, 16

## APPLICABLE ITEMS CHECKED:

	disclosure (page 13)
DESIGN APPLICATION	<pre>(specification, claim, declaration and power of attorney and photograph(s))</pre>
XX FORMAL DRAWINGS	( <u>5</u> sheets) (NI A4)
INFORMAL DRAWINGS	( sheets)
	OVER SHEET and ASSIGNMENT d returned to the undersigned)

XX PRIORITY CLAIM - application			nefit of application(s)
Japan fi	ese 'Patent led July l	Appln. No 4, 2000	. 2000-214847
	ese Patent led	Appln. No	•
	ese Patent led	Appln. No	
	ese Patent led	Appln. No	•
XX_ PRIORITY DOCUMENT(s)			
Enclosed	XX Not	Enclosed	
VERIFIED STATEMENT TO	ESTABLISH	SMALL ENTI	TY STATUS
XX EXPRESS MAIL CERTIFICA	TION		
OTHER -			
XX FEE			
A check is enclosed for	the follo	wing offic	ial fees:
		Large Entity	Small Entity
XX Basic Filing Fee		\$ 710.00	\$
Independent Claims in Excess of 3		\$	<b>\$</b> .
Total Claims in Excess of 20		\$	\$
Multiple Claim Fee		\$	\$
Assignment Recordal	Fee	\$	\$
	TOTAL	\$ 710.00	\$
	Respectfully submitted,		
	ADAMS & W	ILKS for Appl/į	cant(s)
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New York, NY 10004 (212) 809-3700	Bruce L.	Adams 25.386	

Re: New patent application of Ryoichi MATSUOKA

for SEMICONDUCTOR WAFER PATTERN SHAPE EVALUATION METHOD AND DEVICE

comprising transmittal letter, title, specification (pgs.1-12), 16 claims (pgs.10-12), abstract of the disclosure (pg.13), 5 sheets of formal drawings containing thereon Figs. 1-5, express mail certification and check in the amount \$710.00

Attorney's Docket No: S004-4330

## EXPRESS MAIL CERTIFICATION UNDER 37 CFR §1.10

Express Mail Tracking Number: EK 825 216 945 US

Date of Deposit: July 12, 2001

I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR §1.10 on the date indicated above and is addressed to Box PATENT APPLICATION, ASSISTANT COMMISSIONER OF PATENTS, Washington, DC 20231.

Thurano Do Carvalho
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